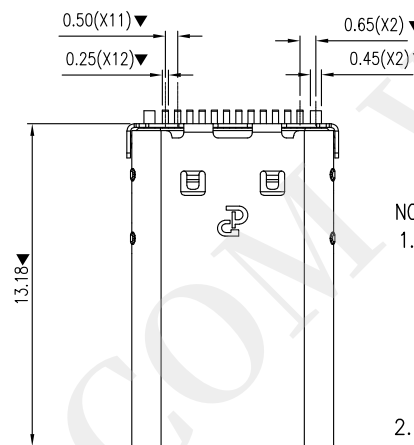
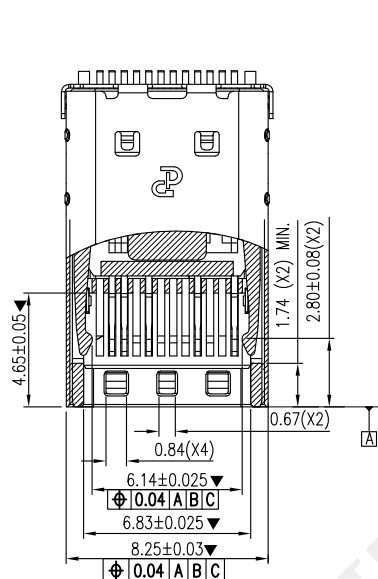
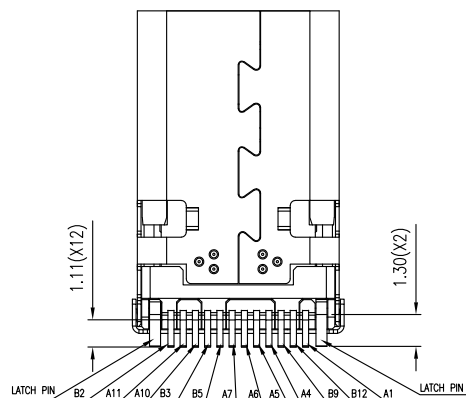
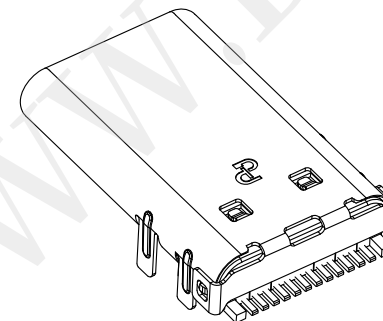
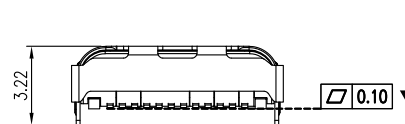
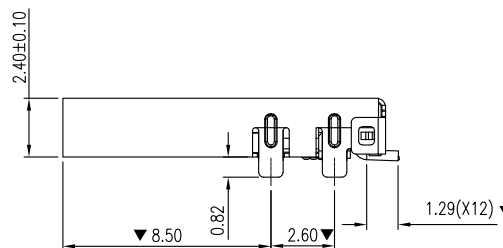
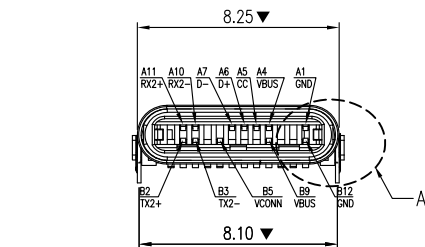




NOTES:

1. MATERIALS:

SHELL: STAINLESS STEEL, T=0.15±0.01mm

SPRING: STAINLESS STEEL, T=0.10±0.01mm

LATCH: STAINLESS STEEL, T=0.40±0.01mm

HOUSING: THERMOPLASTIC

MOLDING1: HIGH-THERMOPLASTIC+ BRONZE, T=0.20±0.01mm

MOLDING2: HIGH-THERMOPLASTIC+ BRONZE, T=0.20±0.01mm

2. PLATING:

CONTACT: CONTACT AREA Au PLATED 30u"Min. OR REFER TO THE

PART NO. CODE DEFINED. UNDER PLATE 80u"Min. NICKEL OVERALL. 120u" Min. TIN PLATING ON SOLDER TAIL

SHELL: 30u"Min. NICKEL PLATING OVERALL

3. ELECTRICAL PERFORMANCE:

INSULATION RESISTANCE: 100Mohm MIN.

CONTACT RESISTANCE: 40mohm MAX.

DIELECTRIC WITHSTANDING: 100 VAC

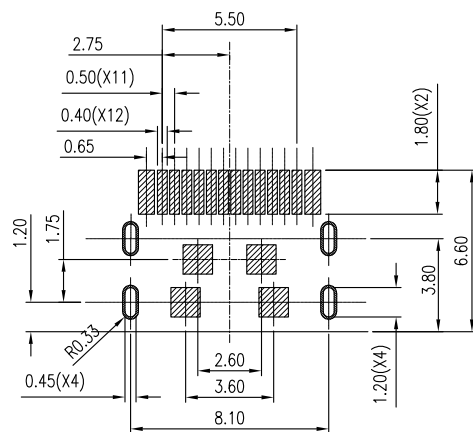
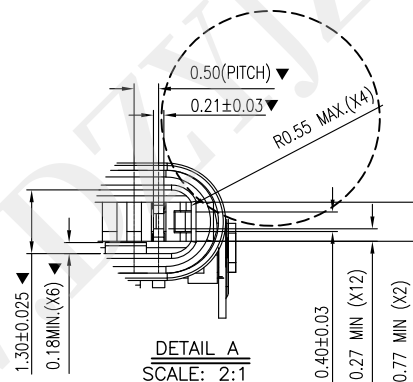
CURRENT RATING: 3A MIN.

4. MECHANICAL PERFORMANCE:

MATING FORCE: 5~20N

UNMATING FORCE: 8~20N

DURABILITY: 10000 CYCLES

RECOMMENDED P.C.B LAYOUT
(T=1.4±0.15)DETAIL A
SCALE: 2:1

深圳市华宇创精密电子有限公司

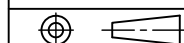
TOLERANCE:

X.X ±0.30

X.XX ±0.25

X.XXX ±0.15

X" ±2° X.X" ±0.5°



UNIT: mm [inch]

SCALE: 1:1 SIZE: A4

DRAWN BY :

陈一鸣

DATE :

2014-02-23

PART NAME:

USB TYPE C 公头12P 四脚插板SMT L=13.18mm

CHECKED BY:

马跃

DATE :

2014-02-23

PART NO.

HYC604-USBC12-132

MOLD NO.

APPROVED BY:

邱敏

DATE :

2014-02-23

DRAW NO:

HYC-2509110920

SHEET NO.

1 OF 1